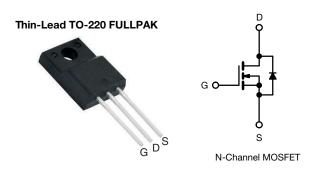
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Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.137			
Q _g max. (nC)	38				
Q _{gs} (nC)	10				
Q _{gd} (nC)	6				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free and halogen-free	SiHA155N60EF-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	- V	
Gate-source voltage e			V _{GS}	± 30		
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	9	А	
	VGS at TO V	T _C = 100 °C		6		
Pulsed drain current ^a			I _{DM}	43	1	
Linear derating factor				0.26	W/°C	
Single pulse avalanche energy ^b			E _{AS}	111	mJ	
Maximum power dissipation			PD	33	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	100	V/ns	
Reverse diode dv/dt ^d				17		
Soldering recommendations (peak temperatur	e) ^c	For 10 s		260	°C	
Mounting torque		M3 screw		0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.8 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

e. Limited by maximum junction temperature

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COMPLIANT

HALOGEN

FREE



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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	-		65				
Maximum junction-to-case (drain)	R _{thJC}	-				- °C/W		
	•							
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherw	ise noted)						
PARAMETER	SYMBOL		T CONDIT	ONS	MIN.	TYP.	MAX.	UNI
Static					•			I
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.62	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 μA	3.0	-	5.0	V
		,	$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I _{GSS}		V _{GS} = ± 30	V	-	-	± 1	μA
			= 480 V, V _{GS}		-	-	1	μA
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	', V _{GS} = 0 V	, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I	= 10 A	-	0.137	0.159	Ω
Forward transconductance	9 _{fs}	V _{DS} = 10 V, I _D = 10 A		-	9.2	-	S	
Dynamic						•		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 100 KHz		-	1465	-	pF	
Output capacitance	C _{oss}			-	56	-		
Reverse transfer capacitance	C _{rss}			-	1	-		
Effective output capacitance, energy related	C _{o(er)}	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		-	61	-		
Effective output capacitance, time related	C _{o(tr)}			-	356	-		
Total gate charge	Qg			-	25	38	1	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 10 A, V _{DS} = 480 V		-	10	-	nC
Gate-drain charge	Q _{gd}				-	6	-	
Turn-on delay time	t _{d(on)}		•		-	20	40	
Rise time	t _r	V _{DD} =	V _{DD} = 480 V, I _D = 10 A,		-	27	54	1
Turn-off delay time	t _{d(off)}	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 10.1 \Omega$		-	28	56	- ns	
Fall time	t _f			-	17	34		
Gate input resistance	Rg	f = 1 MHz, open drain		0.4	0.9	1.8	Ω	
Drain-Source Body Diode Characteris								
Continuous source-drain diode current	IS	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21		
Pulsed diode forward current	I _{SM}			-	-	43	A	
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 10 A	V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C, } I_{S} = 10 \text{ A, } V_{GS} = 0 \text{ V}$ $T_{J} = 25 \text{ °C, } I_{F} = I_{S} = 10 \text{ A,}$ $di/dt = 100 \text{ A}/\mu\text{s, } V_{R} = 400 \text{ V}$		-	95	190	ns	
Reverse recovery charge	Q _{rr}			-	0.5	1.0	μC	
Reverse recovery current	I _{RRM}			-	12	_	A	



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

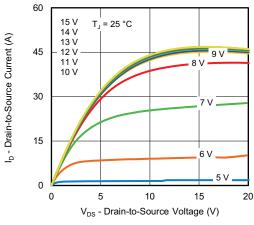


Fig. 1 - Typical Output Characteristics

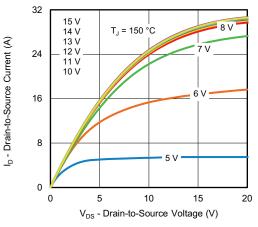


Fig. 2 - Typical Output Characteristics

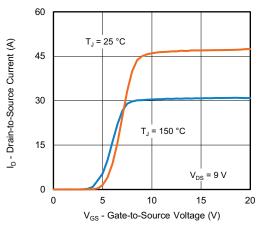


Fig. 3 - Typical Transfer Characteristics

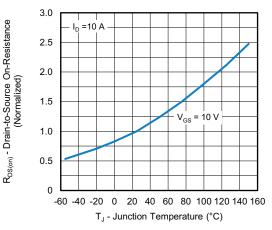


Fig. 4 - Normalized On-Resistance vs. Temperature

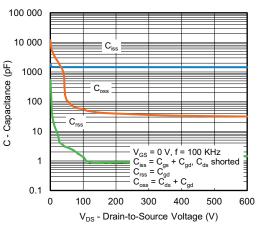
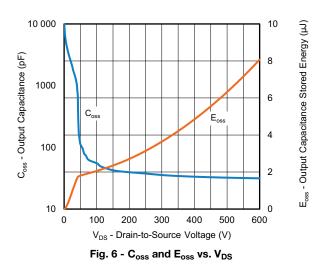


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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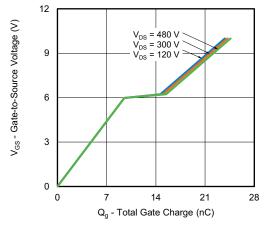


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

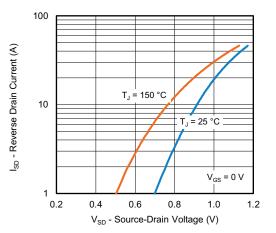


Fig. 8 - Typical Source-Drain Diode Forward Voltage

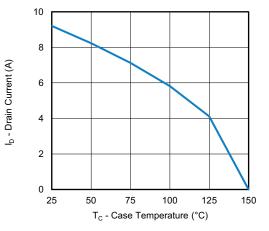


Fig. 9 - Maximum Drain Current vs. Case Temperature

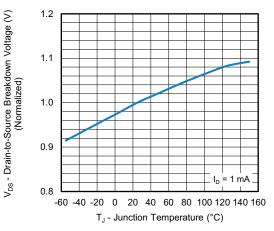


Fig. 10 - Temperature vs. Drain-to-Source Voltage

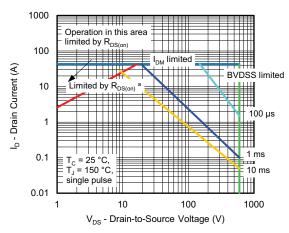


Fig. 11 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

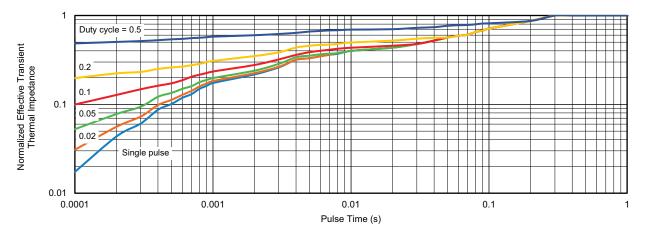
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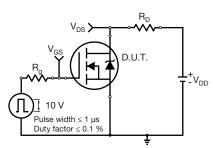


Fig. 13 - Switching Time Test Circuit

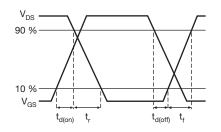


Fig. 14 - Switching Time Waveforms

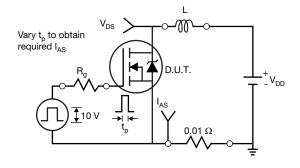


Fig. 15 - Unclamped Inductive Test Circuit

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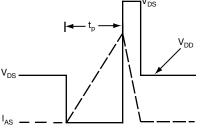


Fig. 16 - Unclamped Inductive Waveforms

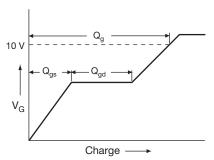
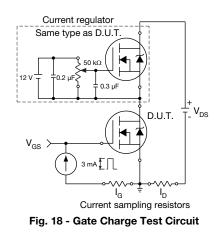
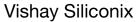


Fig. 17 - Basic Gate Charge Waveform

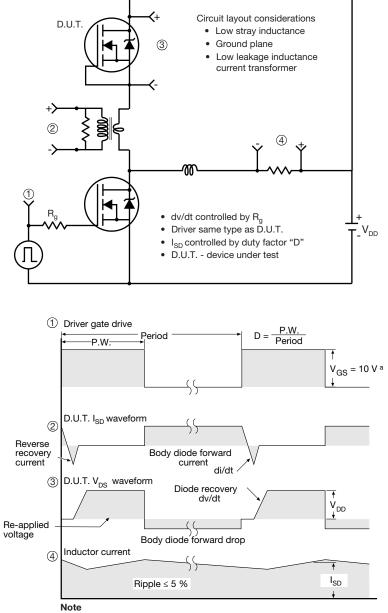


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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

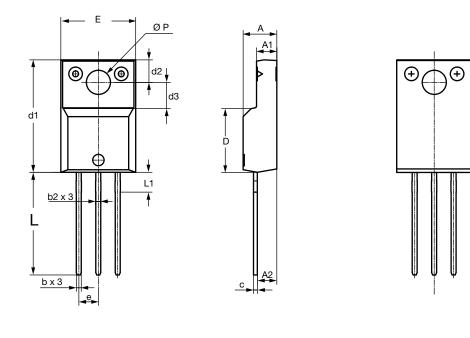
Fig. 19 - For N-Channel

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Vishay Siliconix

TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS		
SYMBOL	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.30	4.70	0.169	0.185	
A1	2.50	2.90	0.098	0.114	
A2	2.40	2.80	0.094	0.110	
b	0.60	0.80	0.024	0.031	
b2	0.60	0.90	0.024	0.035	
С	-	0.60	-	0.024	
D	8.30	8.70	0.327	0.342	
d1	14.70	15.30	0.579	0.602	
d2	2.90	3.10	0.114	0.122	
d3	3.30	3.70	0.130	0.146	
E	9.70	10.30	0.382	0.406	
е	2.50	2.70	0.098	0.106	
L	13.40	13.80	0.528	0.543	
L1	1.00	2.80	0.039	0.110	
ØP	3.00	3.40	0.118	0.134	
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	•			

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